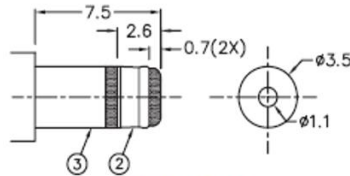
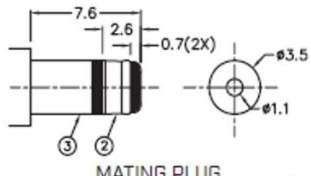
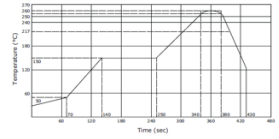
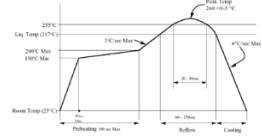
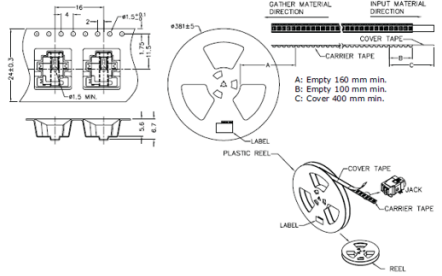
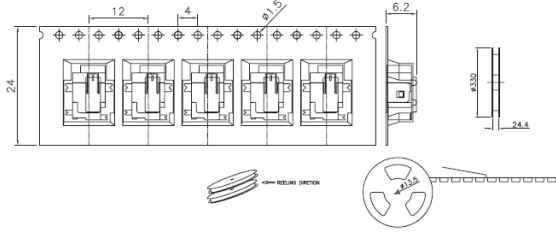


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Affected Date Code: 5/30/2023

Product Availability: Channel Availability Q3

Additional Information:

F-723-001

Revision: A



PCN Approval:

Operations/Quality

Rae Adams

Product Management

RH
